



TITLE: SEMICONDUCTOR DEVICE WITH  
IMPROVED BOND PADS  
Inventor: Rodney C. Langley  
Serial No.: 09/438,692  
Docket No.: 2269-3656US  
REPLACEMENT SHEET

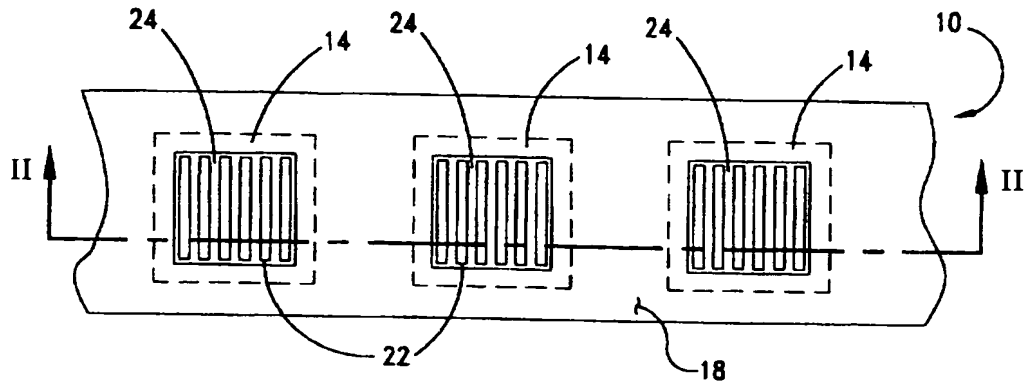


FIG. 1  
(AMENDED)

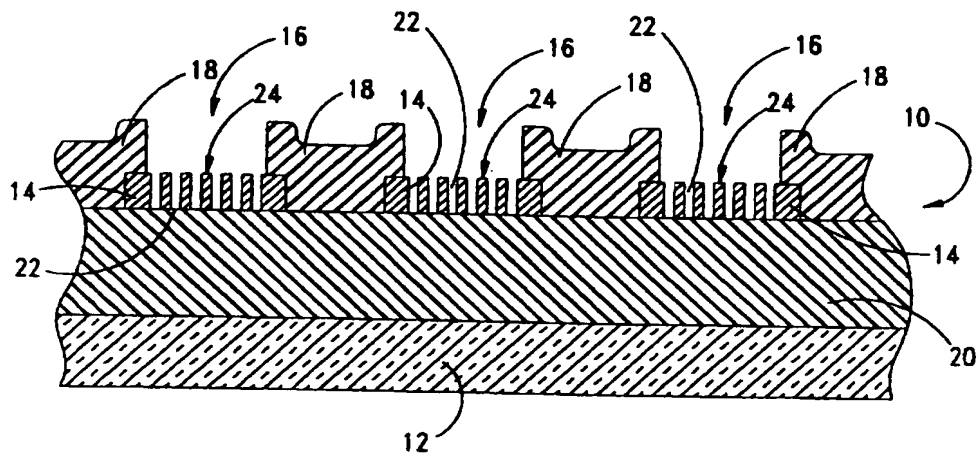


FIG. 2